

## UT100N04

Power MOSFET

100A, 40V N-CHANNEL  
POWER MOSFET

## ■ DESCRIPTION

The UTC **UT100N04** is an N-channel power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance and superior switching performance.

The UTC **UT100N04** is generally applied in low power switching mode power appliances and electronic ballast.

## ■ FEATURES

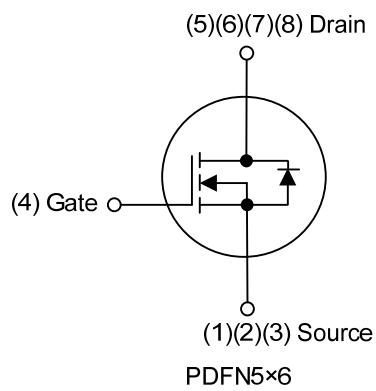
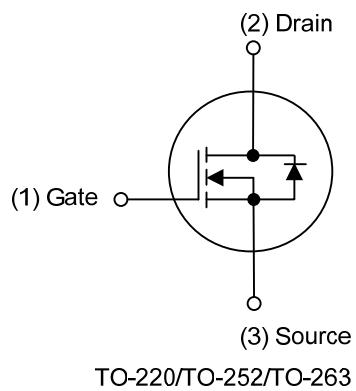
\*  $R_{DS(ON)} \leq 4.8 \text{ m}\Omega$  @  $V_{GS}=10\text{V}$ ,  $I_D=50\text{A}$

$R_{DS(ON)} \leq 6.5 \text{ m}\Omega$  @  $V_{GS}=4.5\text{V}$ ,  $I_D=50\text{A}$

\* High Switching Speed

\* Improved dv/dt capability

## ■ SYMBOL



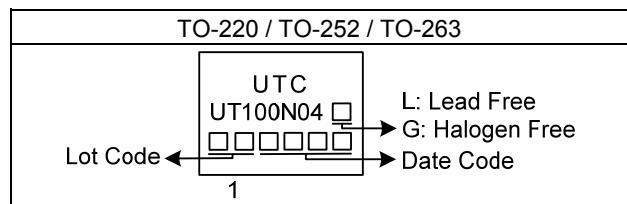
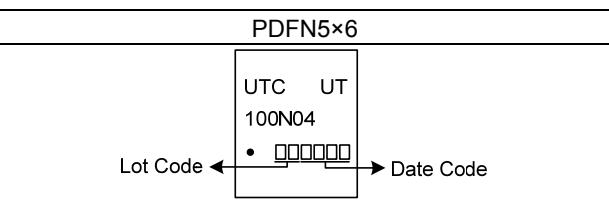
## ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT100N04L-TA3-T	UT100N04G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
UT100N04L-TN3-R	UT100N04G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UT100N04L-TQ2-T	UT100N04G-TQ2-T	TO-263	G	D	S	-	-	-	-	-	Tube
UT100N04L-TQ2-R	UT100N04G-TQ2-R	TO-263	G	D	S	-	-	-	-	-	Tape Reel
UT100N04L-P5060-R	UT100N04G-P5060-R	PDFN5x6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TN3: TO-252, TQ2: TO-263 P5060: PDFN5x6 (3) G: Halogen Free and Lead Free, L: Lead Free		
	(1)Packing Type	(2)Package Type	(3)Green Package

**■ MARKING**

TO-220 / TO-252 / TO-263	PDFN5×6
 <p>L: Lead Free G: Halogen Free Lot Code Date Code 1</p>	 <p>UTC UT 100N04 • Lot Code Date Code</p>

■ ABSOLUTE MAXIMUM RATINGS (Unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	40	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Continuous Drain Current		$I_D$	100	A
Pulsed Drain Current (Note 2)		$I_{DM}$	200	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	125	mJ
Peak Diode Recovery dv/dt		dv/dt	1.56	V/ns
Power Dissipation ( $T_C=25^\circ C$ )	TO-220/TO-263	$P_D$	73	W
	TO-252		60	W
	PDFN5x6		40	W
Junction Temperature		$T_J$	+150	°C
Operation and Storage Temperature		$T_{STG}$	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. L=0.1mH,  $I_{AS}=50A$ ,  $V_{DD}=25V$ ,  $R_G=20\Omega$ , Starting  $T_J=25^\circ C$

4.  $I_{SD} \leq 100A$ ,  $V_{DS}=0V$ ,  $di/dt \leq 200A/\mu s$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-263	$\theta_{JA}$	62.5	°C/W
	TO-252		110	°C/W
	PDFN5x6		40.3 (Note)	°C/W
Junction to Case	TO-220/TO-263	$\theta_{JC}$	1.7	°C/W
	TO-252		2.08 (Note)	°C/W
	PDFN5x6		3.12 (Note)	°C/W

Note: Device mounted on FR-4 substrate  $P_c$  board, 2oz copper, with 1inch square copper plate.

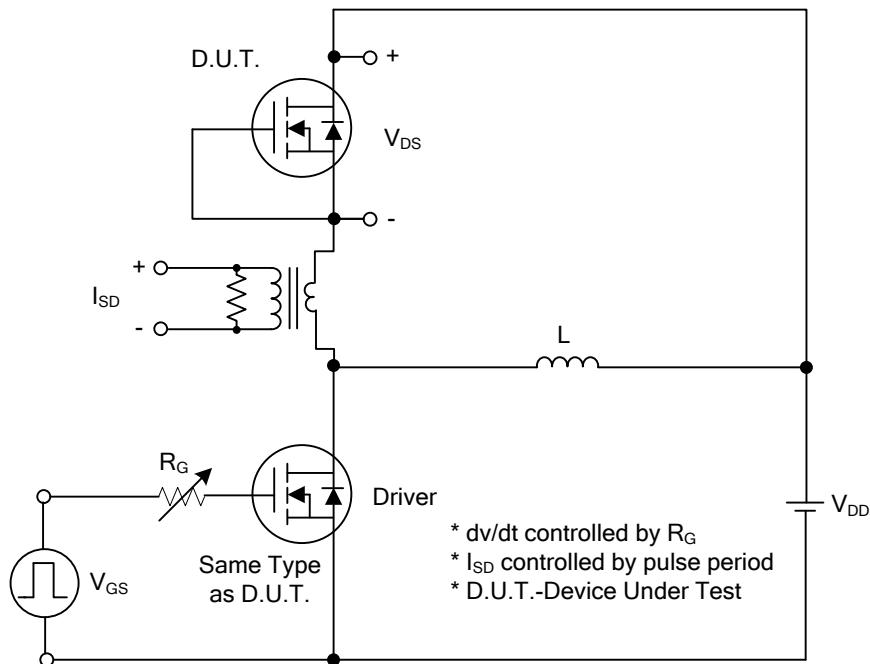
■ ELECTRICAL CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	40			V
Drain-Source Leakage Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=40\text{V}, \text{V}_{\text{GS}}=0\text{V}$		1		$\mu\text{A}$
Gate-Source Leakage Current	Forward	$\text{V}_{\text{GS}}=20\text{V}, \text{V}_{\text{DS}}=0\text{V}$		100	nA	
	Reverse	$\text{V}_{\text{GS}}=-20\text{V}, \text{V}_{\text{DS}}=0\text{V}$		-100	nA	
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$\text{V}_{\text{GS(TH)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1.0		3.0	V
Static Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=50\text{A}$		4.8		$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=50\text{A}$		6.5		$\text{m}\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$\text{C}_{\text{ISS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1\text{MHz}$		3450		pF
Output Capacitance	$\text{C}_{\text{OSS}}$			640		pF
Reverse Transfer Capacitance	$\text{C}_{\text{RSS}}$			580		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	$\text{Q}_G$	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=100\text{A}$ $I_G=1\text{mA}$ (Note1,2)		110		nC
Gate-Source Charge	$\text{Q}_{\text{GS}}$			12		nC
Gate-Drain Charge	$\text{Q}_{\text{GD}}$			25		nC
Turn-On Delay Time	$t_{\text{D(ON)}}$	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=100\text{A},$ $R_G=3\Omega$ (Note1,2)		12		ns
Turn-On Rise Time	$t_R$			19		ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			79		ns
Turn-Off Fall Time	$t_F$			38		ns
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$\text{I}_S$				100	A
Maximum Pulsed Drain-Source Diode Forward Current	$\text{I}_{\text{SM}}$				200	A
Drain-Source Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{I}_S=100\text{A}, \text{V}_{\text{GS}}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time	$t_{\text{rr}}$	$\text{I}_S=50\text{A}, \text{V}_{\text{GS}}=0\text{V},$ $d\text{I}_S/dt=100\text{A}/\mu\text{s}$		44.4		ns
Body Diode Reverse Recovery Charge	$\text{Q}_{\text{rr}}$			26		nC

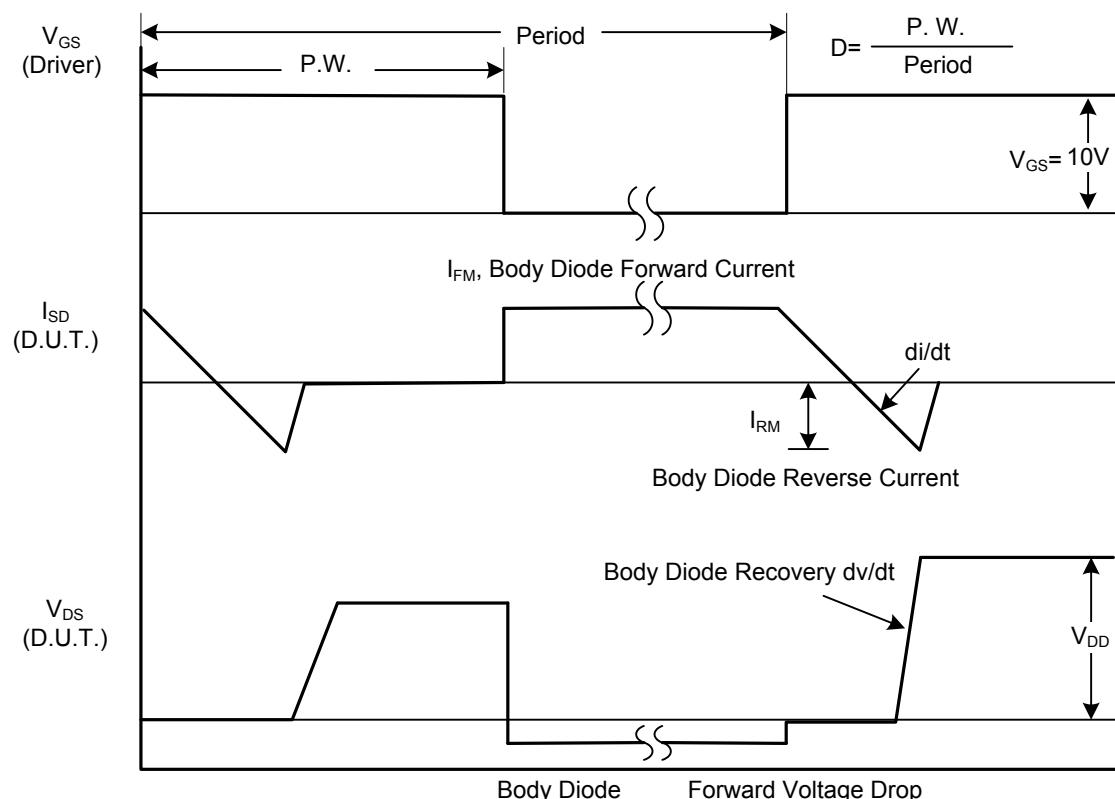
Notes: 1. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

### ■ TEST CIRCUITS AND WAVEFORMS

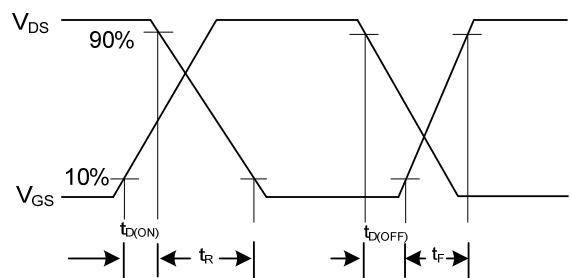
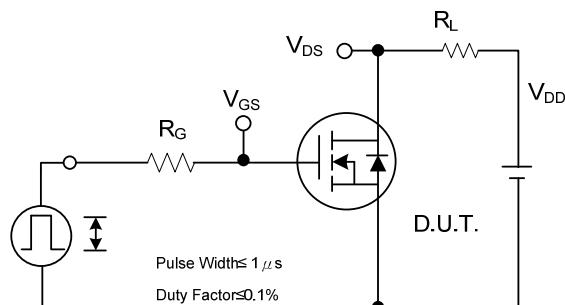


Fig. 2A Switching Test Circuit

Fig. 2B Switching Waveforms

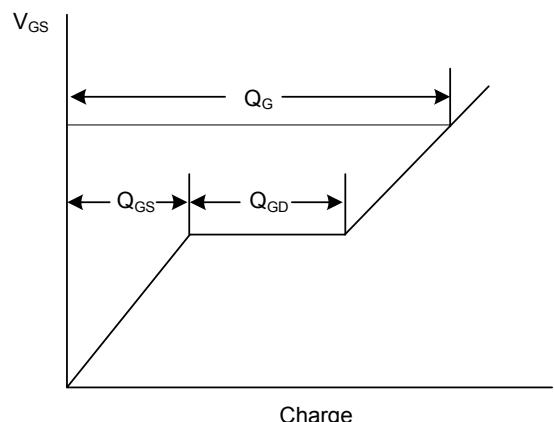
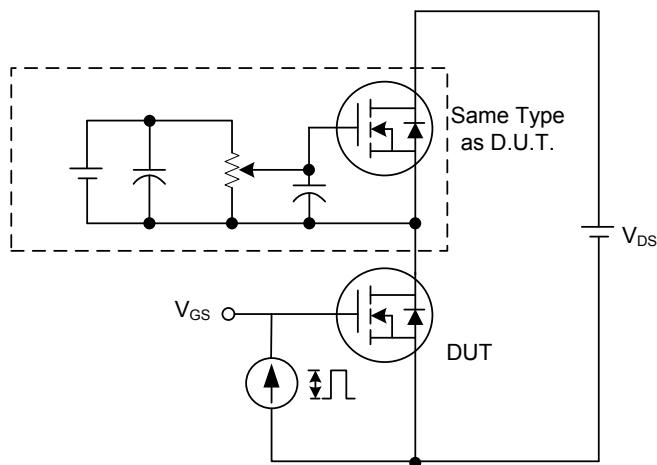


Fig. 3A Gate Charge Test Circuit

Fig. 3B Gate Charge Waveform

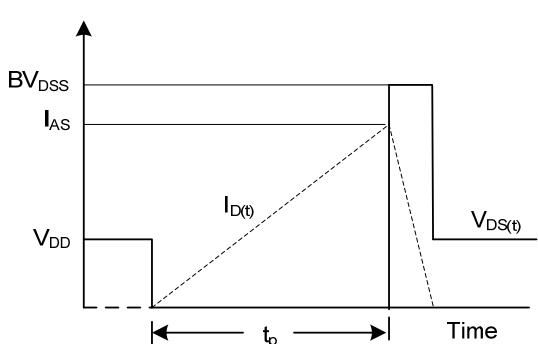
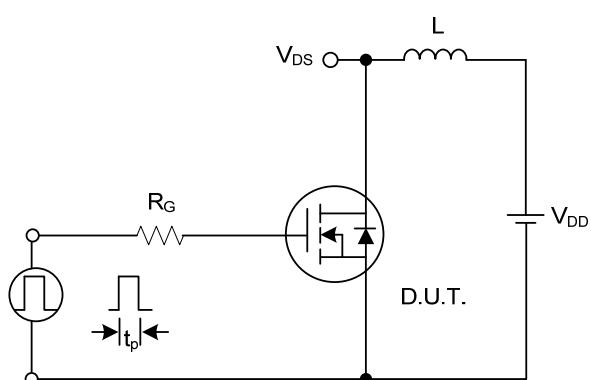
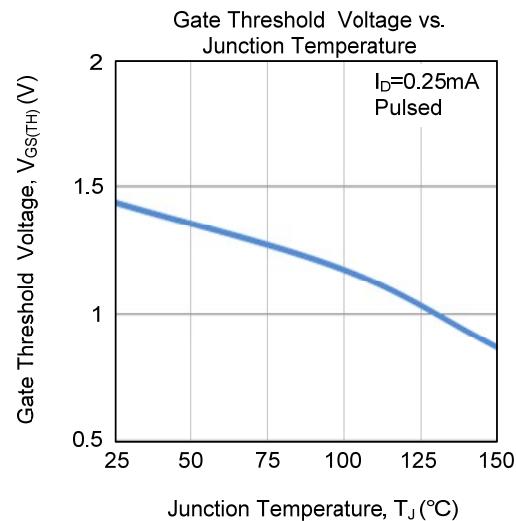
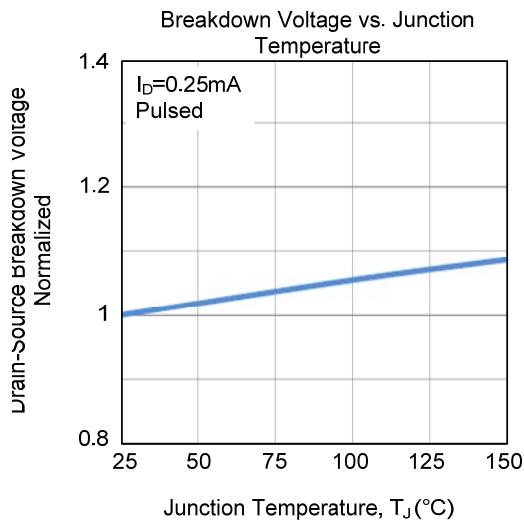
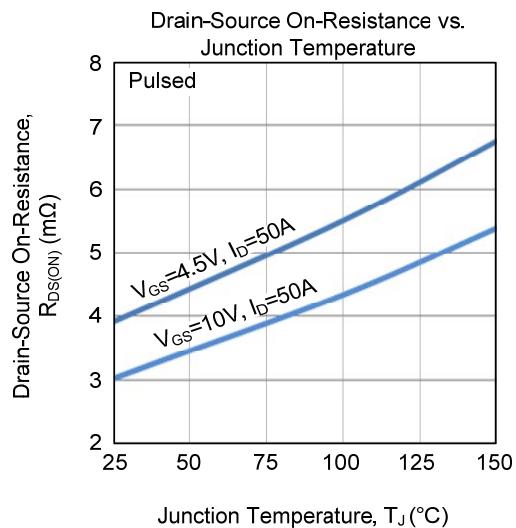
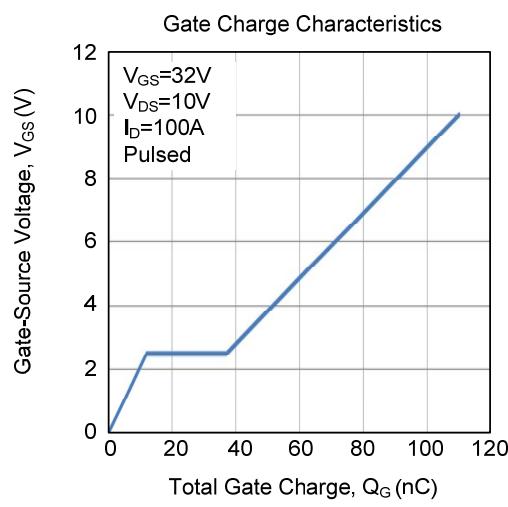
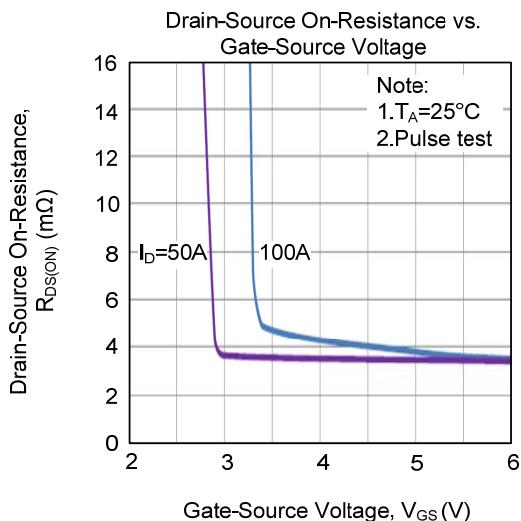
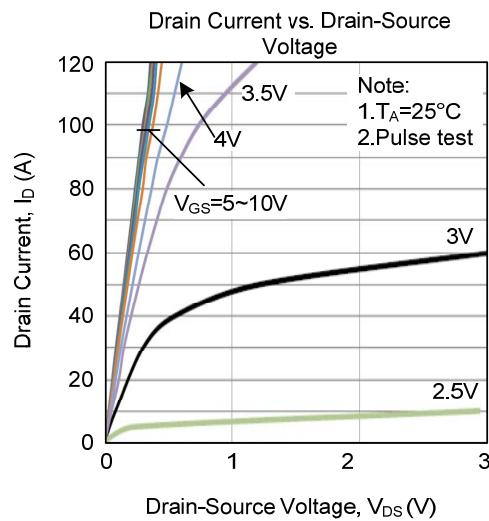


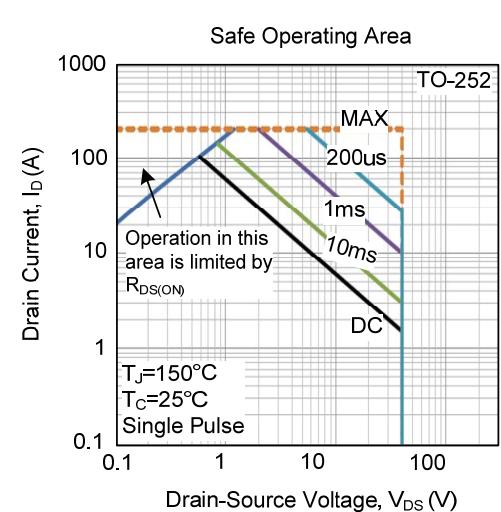
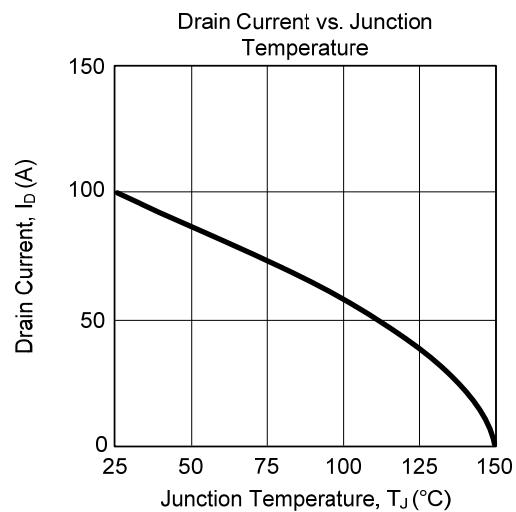
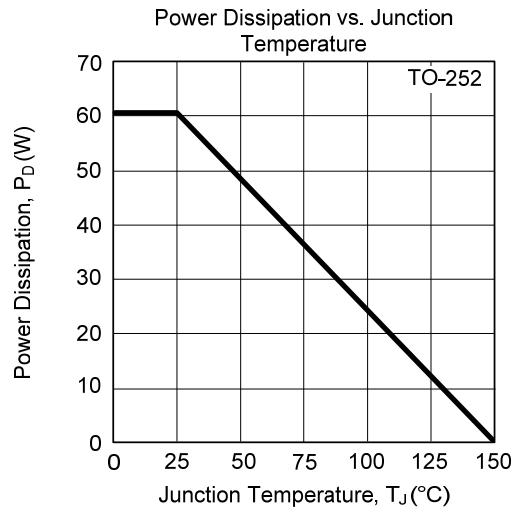
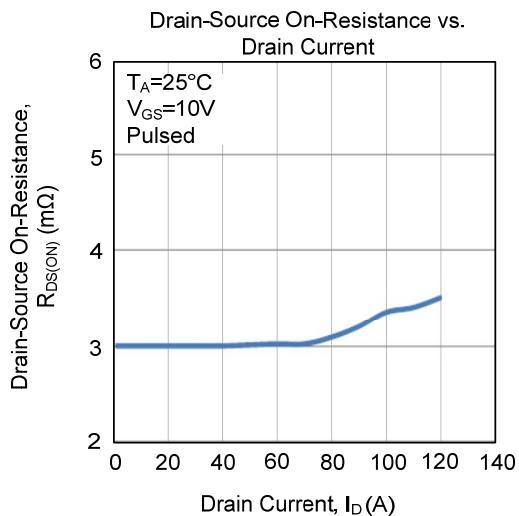
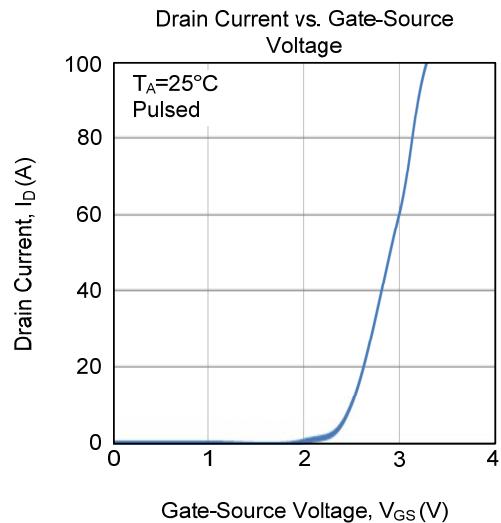
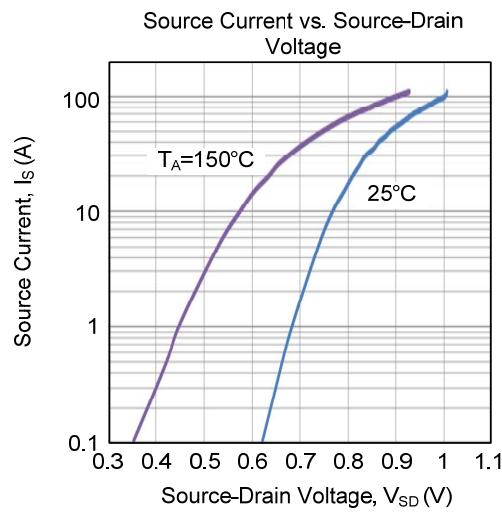
Fig. 4A Unclamped Inductive Switching Test Circuit

Fig. 4B Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



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